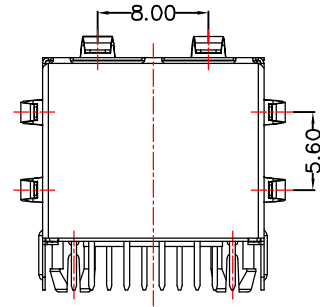
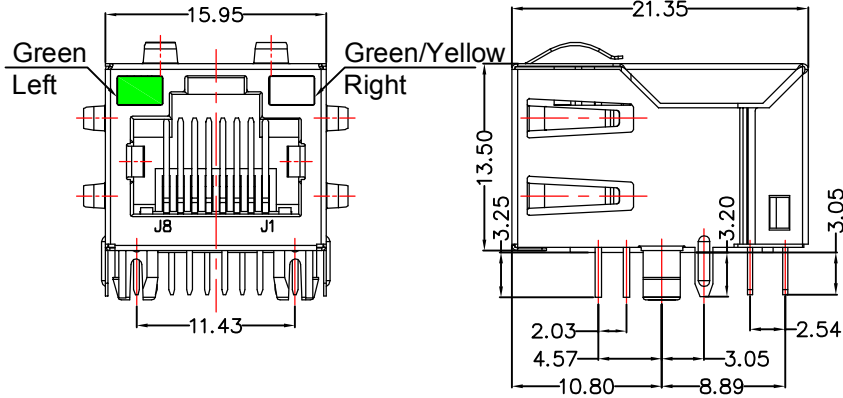


RoHS CONFORM

REV.	ECN / DESCRIPTION	BY	DATE

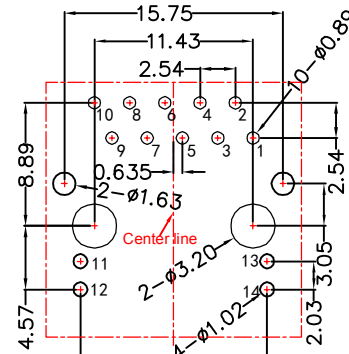
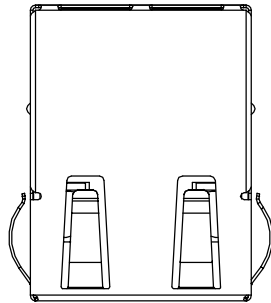
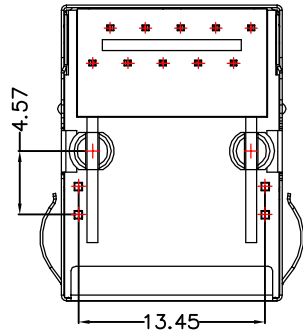


Material:

Housing : PA66+30%GF,UL94V-0,Black.
 Plastic bracket : PA66+30%GF,UL94V-0,Black.
 Shell: C2680R-H,T=0.20mm,Nickel plated on all area.
 Contact terminal: Phosphor bronze C5210R-EH,T=0.35mm,
 Gold plated 6u" on mating area.

Mechanical:

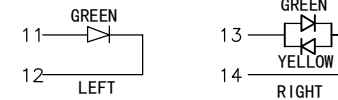
Durability :750 cycles Min.
 Mating force :30N Max.
 Operating temperature:-40°C~+85°C.
 Storage temperature: : -40°C~+85°C.



PCB LAYOUT

SpecificationLED

Standard LED Color	LED Wavelength	Foward(V MAX)	Typical(V TYP)	Luminous Intensity
Green	560-580nm	2.5v	2.1-2.2v	9-25 MCD
Yellow	580-610nm	2.5v	2.1-2.2v	9-30 MCD



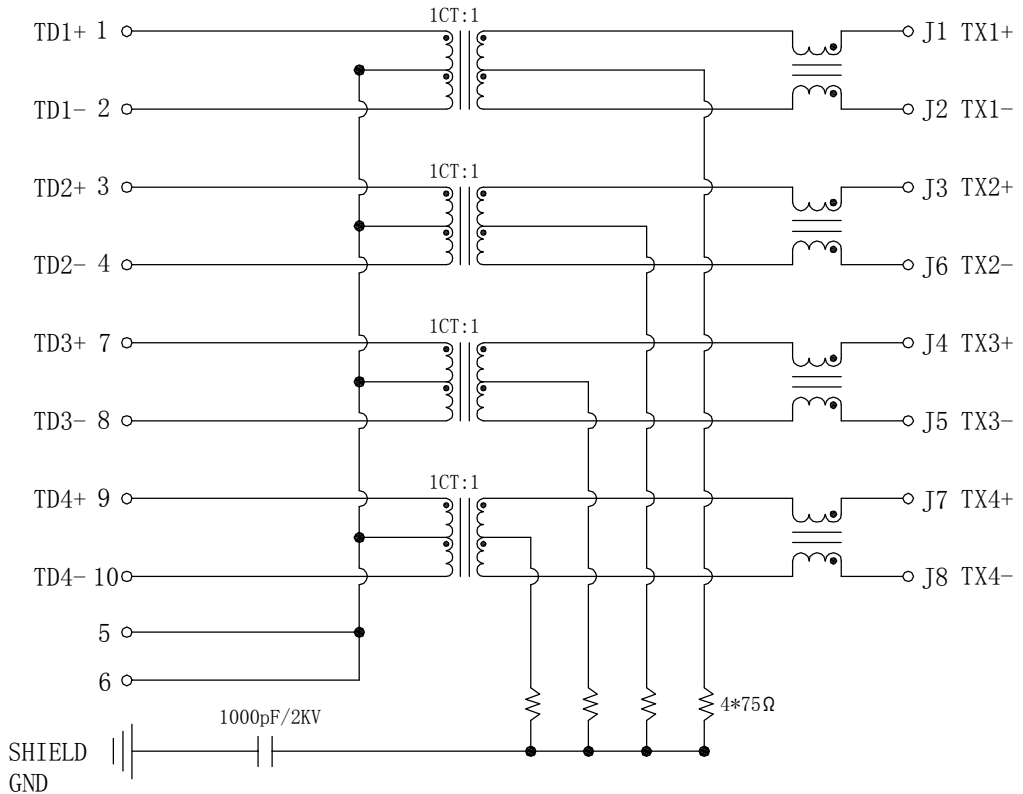
XYFW

深圳市祥云飞武科技有限公司
 Shenzhen City Xiangyunfeiwu Technology Co., Ltd.

TITLE: TAB-UP 1X1 1000BASE	SIZE A4	UNITS MM[INCH]	GENERAL TOLERANCES UNLESS SPECIFIED		APPROVED BY: JP.Gong
PART NO.: RJ-SH202GGYNL	SACLE 1:1	REV A0	x±0.35	x°±3.0°	CHECKED BY: Xu.TW
DWG NO.:	SHEET 1/3		.xx±0.25	.xx°±1.5°	DESIGND BY: Qu.mq
			.xxx±0.10	.xxx°±1.0°	

RoHS CONFORM

REV.	ECN / DESCRIPTION	BY	DATE



Electrical:

1. Insulation resistance: 500 megohms MIN @500VDC.
2. Contact resistance: 20 milliohms Max. initial.
50 milliohms Max. after durability test.
3. Turn Ratio: 1~2: J1~J2=1CT:1CT(±2%).
3~4: J3~J6=1CT:1CT(±2%).
7~8: J4~J5=1CT:1CT(±2%).
9~10: J7~J8=1CT:1CT(±2%).
4. OCL: 350uH Min. at 100KHz 100mV 8mA DC.
5. Insertion Loss: -1.0 dB Max 1MHz to 100MHz.
6. Return loss: -16dB Min From 1MHz to 30MHz;
-14dB Min From 30MHz to 60MHz;
-10dB Min From 60MHz to 80MHz.
7. Cross talk: -40dB Min From 1MHz-30MHz;
-35dB Min From 30MHz-60MHz;
-30dB Min From 60MHz-100MHz;
8. CMR: -35dB Min From 1MHz-100MHz;
9. Hi-Pot: 1500V AC 6S 1mA

XYFW

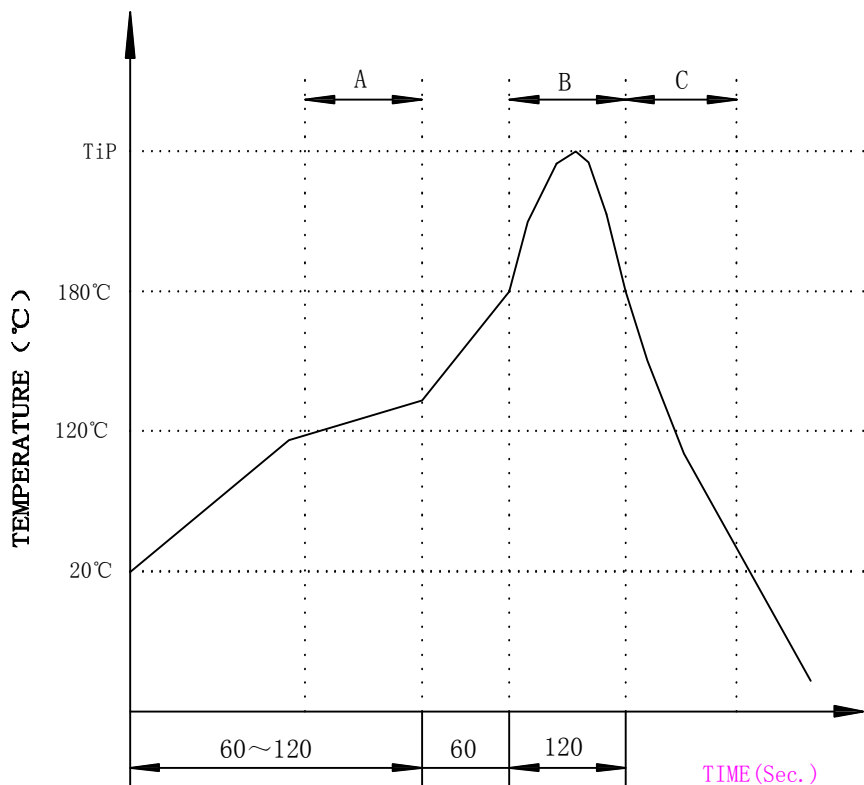
深圳市祥云飞武科技有限公司
Shenzhen City Xiangyunfeiwu Technology Co., Ltd.

TITLE: TAB-UP 1X1 1000BASE	SIZE A4	UNITS MM[INCH]	GENERAL TOLERANCES UNLESS SPECIFIED		APPROVED BY: JP.Gong
PART NO.: RJ-SH202GGYNL	SACLE 1:1	REV A0	x±0.35	x°±3.0°	CHECKED BY: Xu.TW
DWG NO.:	SHEET 2/3		.xx±0.25	.xx°±1.5°	DESIGND BY: Qu.mq
			.xxx±0.10	.xxx°±1.0°	

RoHS CONFORM

PROFILE OF WAVE SOLDER

REV.	ECN / DESCRIPTION	BY	DATE



A.Preheating B.Soldering C.Gradual Cooling
 Tip temperature:260±5°C.
 Tip temperature time:5Sec Max.
 Tip melting point of Sn96.5/Ag3/Cu0.5:217°C.

After the wave solder, the plastic column of product under the pcb will have a slight plastic melting situation .

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TITLE: TAB-UP 1X1 1000BASE	SIZE A4	UNITS MM[INCH]	GENERAL TOLERANCES UNLESS SPECIFIED		APPROVED BY: JP.Gong
PART NO.: RJ-SH202GGYNL	SACLE 1:1	REV A0	x±0.35	x°±3.0°	CHECKED BY: Xu.TW
DWG NO.:	SHEET 3/3		.xx±0.25	.xx°±1.5°	
			.xxx±0.10	.xxx°±1.0°	DESIGND BY: Qu.mq